

A

B

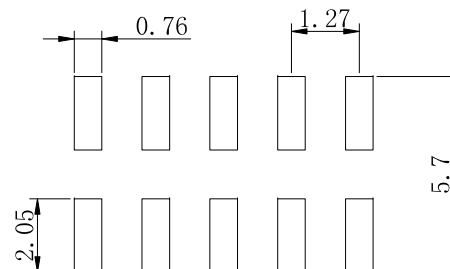
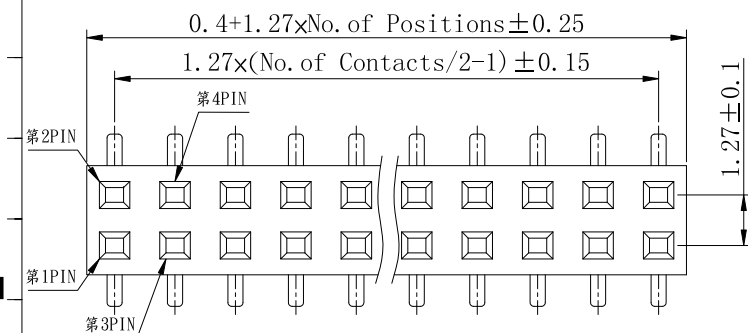
C

D

E

1

1



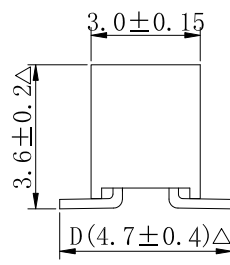
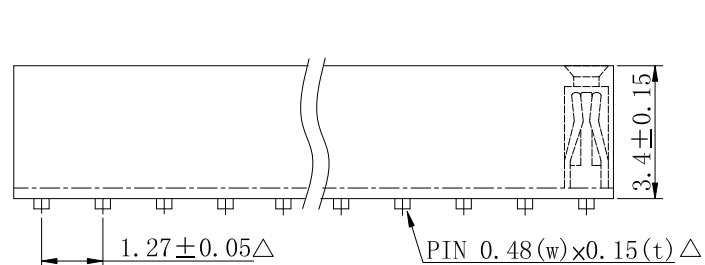
P. C. Board Hole Layout

Specifications

Current Rating	:1 Amp
Insulator Resistance	:1000 Megohms Min.
Contact Resistance	:20 m ohms max.
Dielectric Withstanding	:AC 500 V
Operating Temperature	: $-40^{\circ}\text{C} \sim +105^{\circ}\text{C}$
Soldering Temperature	: 260°C for 3~5sec Max.
Contact Material	:Phosphor Bronze
Insulator Material	:Polyester, UL 94V-0
Standard	:LCP/NL-6T/NL-9T
Finish	:Gold Plated
Standard	:Gold Flash all over

2

2



Series

F604

(Female Header
Dual Row)
F604 (1.27 H:3.4)

Connector
Type

X

M:SMT Type

Contact
Plating

X

G:Gold Flash
T:Tin Plated
A:10U"Gold
B:15U"Gold
C:20U"Gold
©Duplex Plating
D:Gold Flash/Tin
(Standard:G)

Material

X

N:Nylon-6T
N1:Nylon-9T
C:LCP
(Standard:C)

Pin Length mm

DXXX

M-D
D047

Number of
Contacts

-XX

(04 TO 80
Contacts)

3

3



DESCRIPTION(内容):

1.27mm Female Header H:3.4 W:3.0
SMT (RoHS)

PART NO:
(料 號)

F604-MG_-D047-XX

DWG NO(圖號): RDA140319-009

DRAWN(製圖):

GONG

CHECKED(確認):

TERESA

APPROVAL(核准):

JOHNNY

GENERAL TOLERANCE:
(公差)

.X .XXXX
.XX .X °
.XXX .XX °

SCALE(比例):

XX:XX



REV:
A/3

UNIT:
mm

SIZE:

A4

SHEET:

1/1

REV

1

2

3

4

DESCRIPTION

△此符號表示重點管控尺寸

新增NY6T材質選項

新增NY9T材質選項

DATE

2014.03.19

2016.08.01

2017.09.25

A

B

C

D

E